

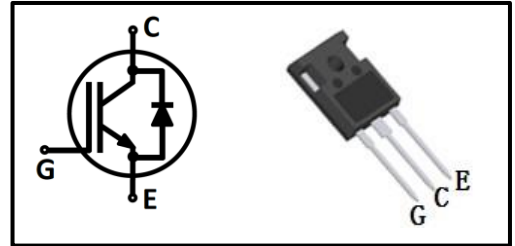
## Features

- Easy parallel switching capability due to positive temperature coefficient in  $V_{CEsat}$
- Low  $V_{CEsat}$ , fast switching
- High ruggedness, good thermal stability
- Very tight parameter distribution

## Applications

- UPS
- PFC

Type	Marking	Package Code
MPBW50N65EH	MP50N65EH	TO-247-3



## Maximum Rated Values <sup>1</sup>

Parameter	Symbol	Value	Unit
Collector-emitter voltage	$V_{CE}$	650	V
DC collector current <sup>2</sup>			A
$T_C=25^\circ\text{C}$	$I_C$	80	
$T_C=100^\circ\text{C}$		50	
Pulsed collector current <sup>3</sup>	$I_{Cpuls}$	200	
Diode forward current <sup>2</sup>			
$T_C=25^\circ\text{C}$	$I_F$	40	
$T_C=100^\circ\text{C}$		20	
Diode pulsed current <sup>3</sup>	$I_{Fpuls}$	150	
Gate-emitter voltage	$V_{GE}$	$\pm 20$	V
Transient Gate-emitter voltage ( $t_p \leq 10\mu\text{s}$ )		$\pm 30$	
Power dissipation			W
$T_C=25^\circ\text{C}$	$P_{tot}$	300	
$T_C=100^\circ\text{C}$		150	
Operating junction temperature	$T_j$	-55~175	$^\circ\text{C}$
Storage temperature	$T_{stg}$	-55~150	

1:Reference standard: JESD-022 2: limited by  $T_{jmax}$  3:  $T_p$  limited by  $T_{jmax}$  ;



### Thermal Characteristics

Parameter	Symbol	Min	Typ	Max	Unit
IGBT thermal resistance, junction-case	$R_{thJC}$	-	-	0.5	K/W
Diode thermal resistance, junction-case	$R_{thJCD}$	-	-	0.65	
Thermal Resistance, junction-ambient	$R_{thJA}$	-	-	40	

### Electrical Characteristics (at $T_j=25^\circ\text{C}$ , unless otherwise specified) Static Characteristics

Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Collector-emitter breakdown voltage	$V_{(BR)CES}$	$V_{GE}=0V, I_C=0.25mA$	650	-	-	V
Collector-emitter saturation voltage	$V_{CE(sat)}$	$V_{GE}=15V, I_C=50A, T_j=25^\circ\text{C}$	-	1.60	1.90	
		$T_j=125^\circ\text{C}$	-	1.90	-	
		$T_j=150^\circ\text{C}$	-	1.95	-	
Diode forward voltage	$V_F$	$V_{GE}=0V, I_F=20A, T_j=25^\circ\text{C}$	-	1.50	1.90	
		$T_j=125^\circ\text{C}$	-	1.40	-	
		$T_j=150^\circ\text{C}$	-	1.35	-	
G-E threshold voltage	$V_{GE(th)}$	$I_C=1mA, V_{CE}=V_{GE}$	4.5	5.5	6.5	
C-E leakage current	$I_{CES}$	$V_{CE}=650V, V_{GE}=0V, T_j=25^\circ\text{C}$	-	-	0.01	
		$T_j=150^\circ\text{C}$	-	-	1.0	
G-E leakage current	$I_{GES}$	$V_{CE}=0V, V_{GE}=20V$	-	-	250	nA
Transconductance	$g_{FS}$	$V_{CE}=20V, I_C=50A$	-	21	-	S

### Dynamic Characteristics

Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Input capacitance	$C_{iss}$	$V_{CE}=25V, V_{GE}=0V, f=1MHz$	-	5810	-	pF
Output capacitance	$C_{oss}$		-	130	-	
Reverse transfer capacitance	$C_{riss}$		-	65	-	
Gate charge	$Q_G$	$V_{CC}=300V, I_C=50A, V_{GE}=15V$	-	230	-	nC



### IGBT Switching Characteristics

Parameter	Symbol	Conditions	Min	Typ	Max	Unit	
Turn-on delay time	$t_{d(on)}$	$T_j=25^{\circ}\text{C}$ , $V_{CC}=400\text{V}$ , $I_C=50\text{A}$ , $V_{GE}=0/15\text{V}$ , $R_G=10\Omega$ , Inductive load	-	75	-	ns	
Rise time	$t_r$		-	73	-		
Turn-off delay time	$t_{d(off)}$		-	330	-		
Fall time	$t_f$		-	68	-		
Turn-on energy	$E_{on}$		$T_j=125^{\circ}\text{C}$ , $V_{CC}=400\text{V}$ , $I_C=50\text{A}$ , $V_{GE}=0/15\text{V}$ , $R_G=10\Omega$ , Inductive load	-	1.37	-	mJ
Turn-off energy	$E_{off}$			-	1.32	-	
Total switching energy	$E_{ts}$			-	2.69	-	
Turn-on delay time	$t_{d(on)}$	$T_j=125^{\circ}\text{C}$ , $V_{CC}=400\text{V}$ , $I_C=50\text{A}$ , $V_{GE}=0/15\text{V}$ , $R_G=10\Omega$ , Inductive load	-	70	-	ns	
Rise time	$t_r$		-	65	-		
Turn-off delay time	$t_{d(off)}$		-	350	-		
Fall time	$t_f$		-	77	-		
Turn-on energy	$E_{on}$		$T_j=125^{\circ}\text{C}$ , $V_{CC}=400\text{V}$ , $I_C=50\text{A}$ , $V_{GE}=0/15\text{V}$ , $R_G=10\Omega$ , Inductive load	-	1.70	-	mJ
Turn-off energy	$E_{off}$			-	1.65	-	
Total switching energy	$E_{ts}$			-	3.35	-	

### Diode Characteristics

Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Diode reverse recovery time	$t_{rr}$	$T_j=25^{\circ}\text{C}$ , $V_R=400\text{V}$ , $I_F=20\text{A}$ , $di_F/dt=220\text{A}/\mu\text{s}$	-	88	-	ns
Diode reverse recovery charge	$Q_{rr}$		-	0.24	-	$\mu\text{C}$
Diode peak reverse recovery current	$I_{rrm}$		-	6.0	-	A
Diode reverse recovery time	$t_{rr}$	$T_j=125^{\circ}\text{C}$ , $V_R=400\text{V}$ , $I_F=20\text{A}$ , $di_F/dt=220\text{A}/\mu\text{s}$		230		ns
Diode reverse recovery charge	$Q_{rr}$			1.05		$\mu\text{C}$
Diode peak reverse recovery current	$I_{rrm}$			10		A

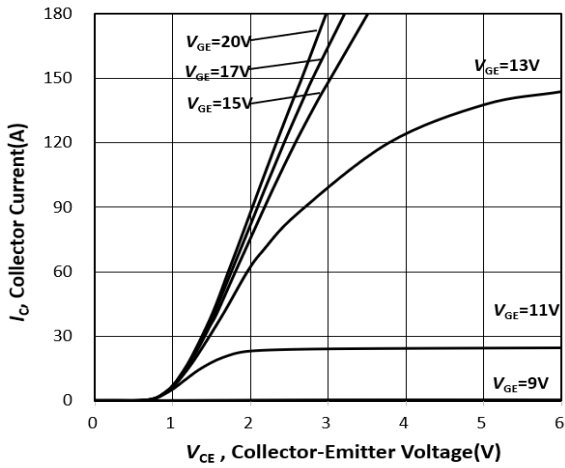


Figure 1. Typical output characteristic ( $T_j = 25^\circ \text{C}$ )

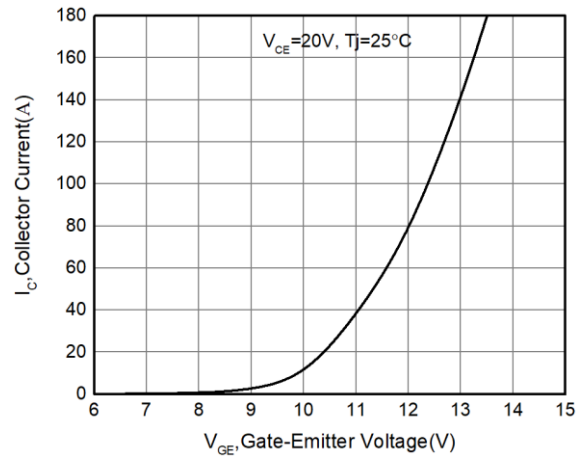


Figure 2. Typical transfer characteristic ( $T_j = 25^\circ \text{C}$ )

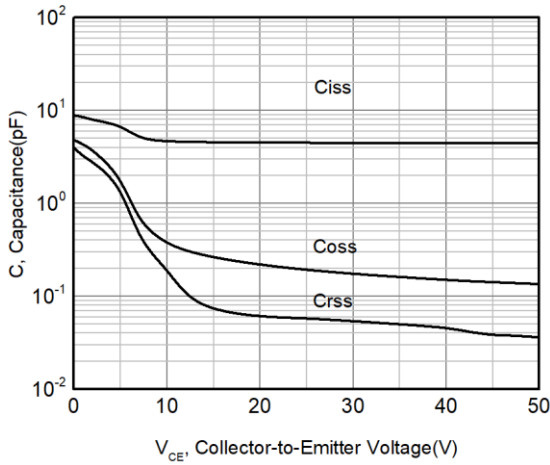


Figure 3. Capacitance characteristic ( $V_{GE} = 0\text{V}$ ,  $f = 1\text{MHz}$ )

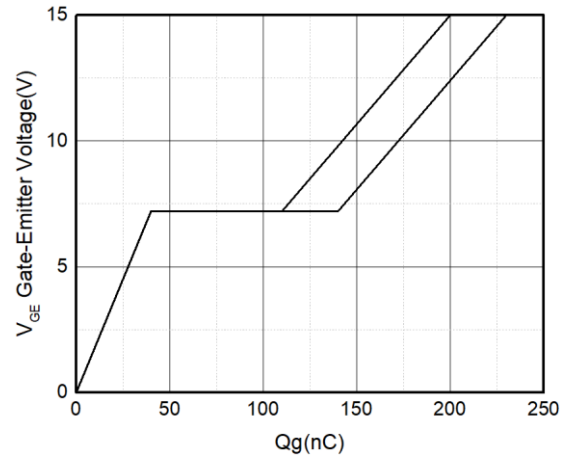


Figure 4. Typical gate charge ( $I_C = 50\text{A}$ )

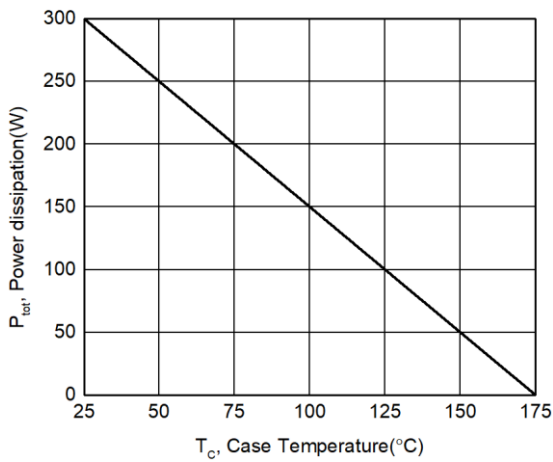


Figure 5. Power dissipation as a function of case temperature ( $T_j \leq 175^\circ \text{C}$ )

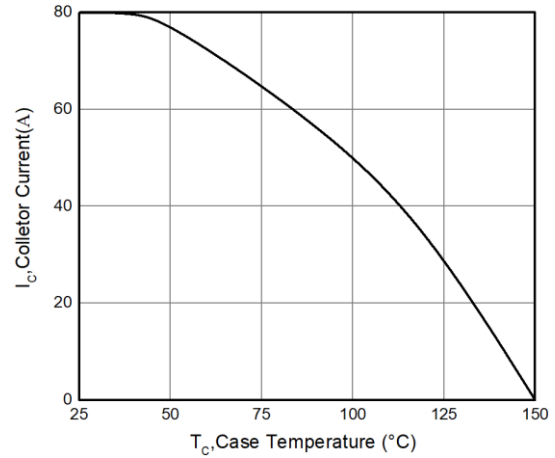


Figure 6. Collector current as a function of case temperature ( $V_{GE} \geq 15\text{V}$ ,  $T_j \leq 150^\circ \text{C}$ )

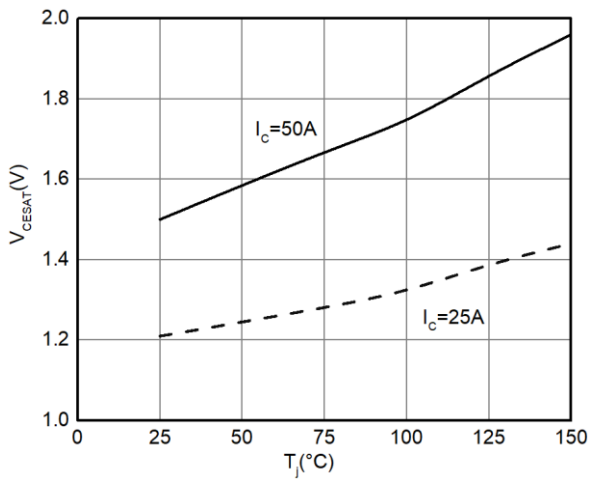


Figure 7.  $V_{CESAT}$  as a function of junction temperature ( $V_{GE}=15V$ )

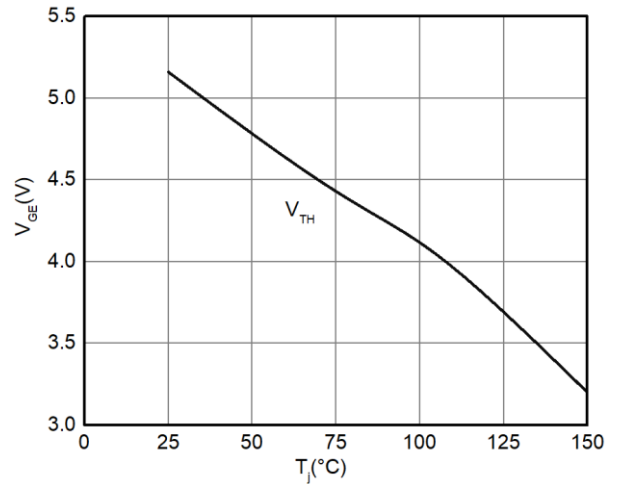


Figure 8.  $V_{TH}$  as a function of junction temperature ( $I_{CE}=250\mu A$ )

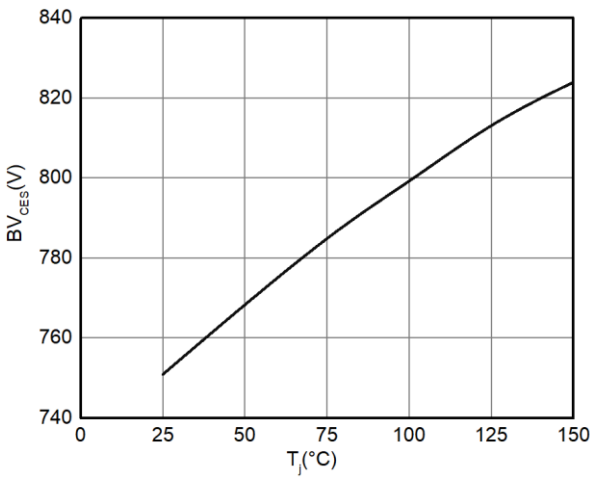


Figure 9. BV as a function of junction temperature ( $I_{CE}=250\mu A$ )

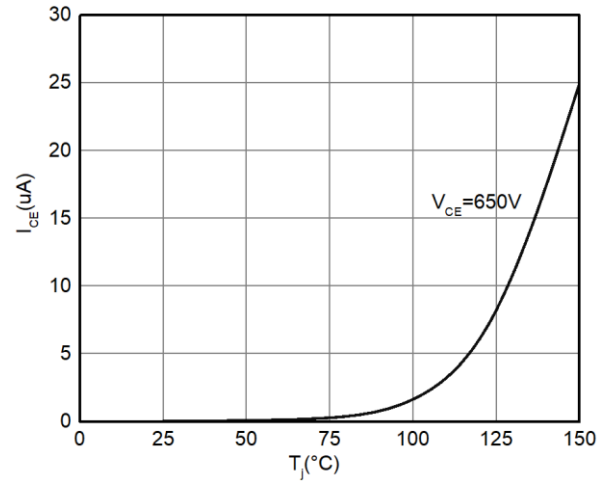


Figure 10.  $I_{CES}$  leakage current as a function of junction temperature

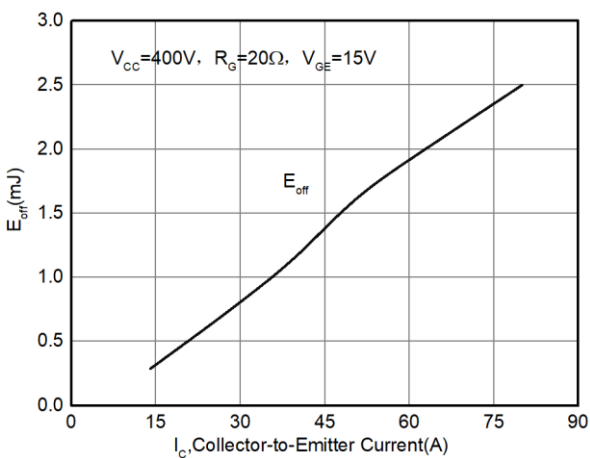


Figure 11.  $E_{off}$  as a function of  $I_C$  ( $T_j=25^\circ C$ )

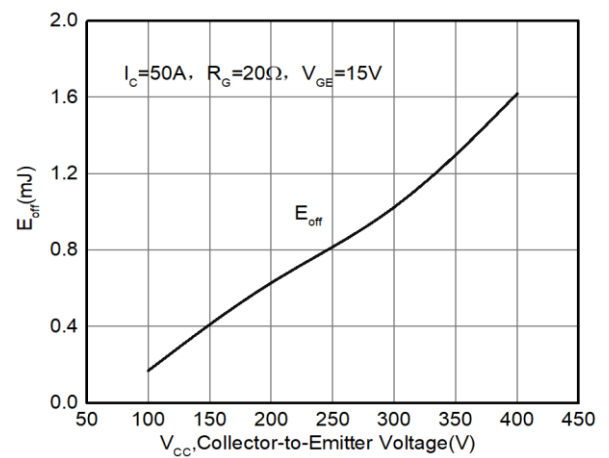


Figure 12.  $E_{off}$  as a function of  $V_{CE}$  ( $T_j=25^\circ C$ )

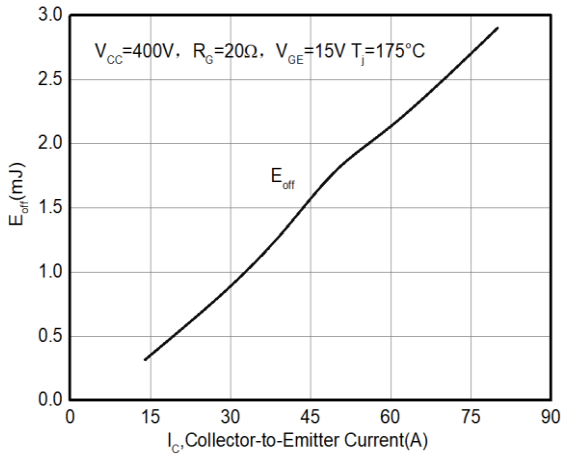


Figure 13.  $E_{off}$  as a function of  $I_C$  ( $T_j = 175^\circ C$ )

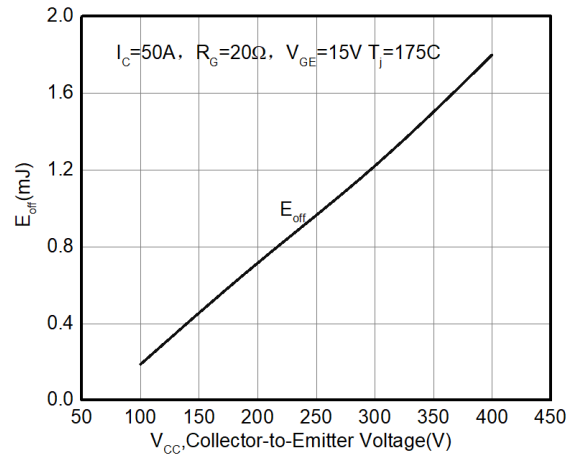


Figure 14.  $E_{off}$  as a function of  $V_{CE}$  ( $T_j = 175^\circ C$ )

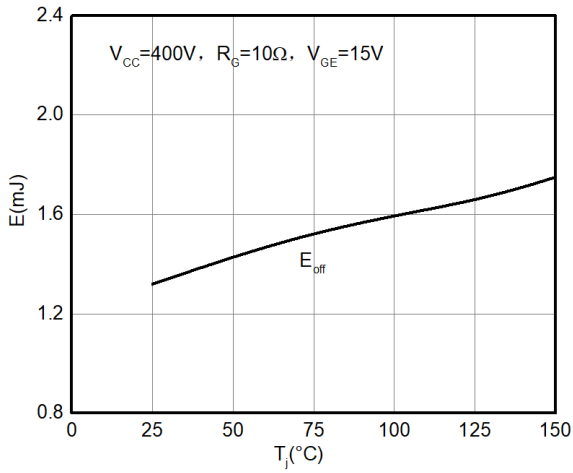


Figure 15.  $E_{off}$  as a function of junction temperature

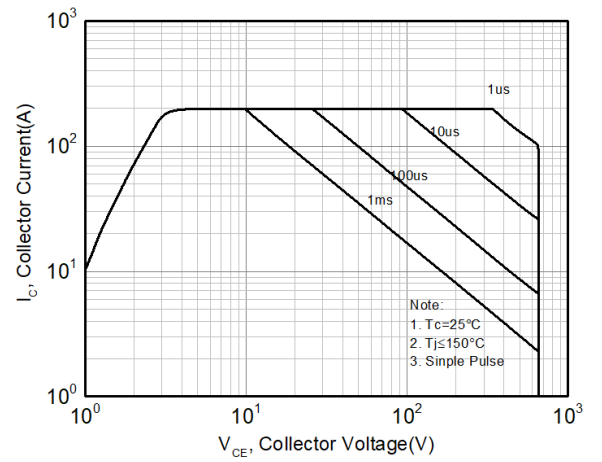
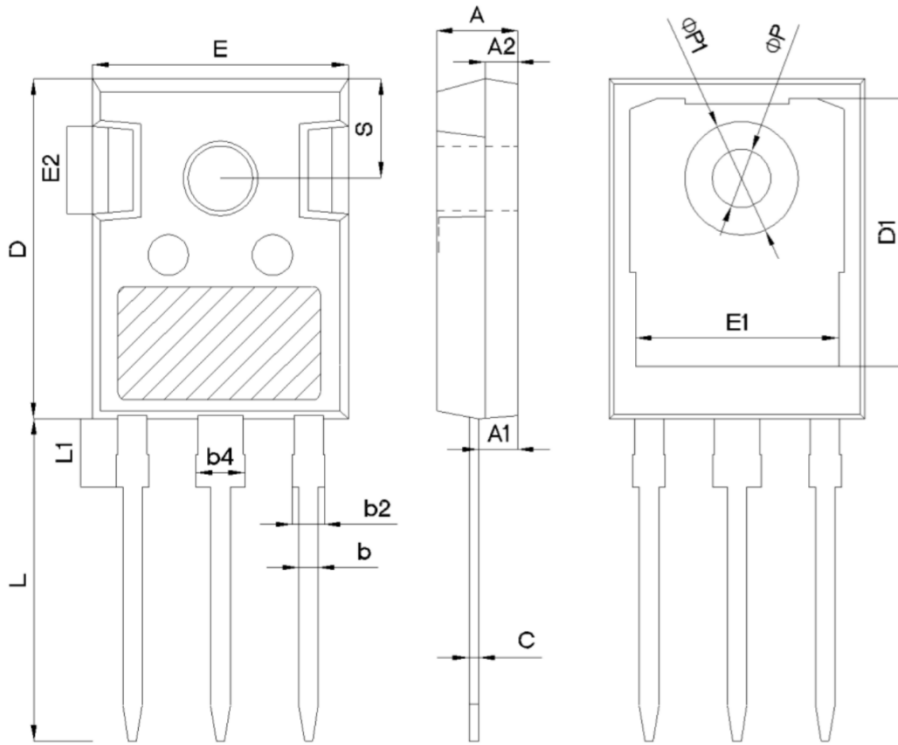


Figure 16. FBSOA

TO-247



SYMBOL	mm		
	MIN	NOM	MAX
A	4.80	5.00	5.20
A1	2.21	2.41	2.61
A2	1.85	2.00	2.15
b	1.11	1.21	1.36
b2	1.91	2.01	2.21
b4	2.91	3.01	3.21
c	0.51	0.61	0.75
D	20.70	21.00	21.30
D1	16.25	16.55	16.85
E	15.50	15.80	16.10
E1	13.00	13.30	13.60
E2	4.80	5.00	5.20
E3	2.30	2.50	2.70
e	5.44BSC		
L	19.62	19.92	20.22
L1	-	-	4.30
ΦP	3.40	3.60	3.80
ΦP1	-	-	7.30
S	6.15BSC		



**Revision: 2020-05-21, Rev. 1.0**

Revision	Date	Subjects (major changes since last revision)
1.0	2020-05-21	





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